

---

### **In the Claims**

Claims 1-78 (canceled).

Claim 79 (new): A semiconductor fabrication apparatus, comprising:

a substrate support assembly configured to support a substrate for fabrication;

a plurality of lamps positioned above the substrate; and

a plurality of reflectors above the lamps, wherein the reflectors have a rugged reflective surface that does not extend below the lamps.

Claim 80 (new): The apparatus of claim 79 wherein the rugged reflective surface of the reflectors is concave.

Claim 81 (new): The apparatus of claim 79 wherein the shape of the rugged reflective surface of the reflectors compliments the shape of the surface of the lamps.

Claim 82 (new): The apparatus of claim 79 wherein the lamps have a convex surface and the reflectors have a concave rugged reflective surface.

Claim 83 (new): The apparatus of claim 79 wherein the rugged reflective surface of the reflectors comprises a repeating pattern.

Claim 84 (new): The apparatus of claim 79 wherein the rugged reflective surface of the reflectors comprises a honeycomb pattern.

Claim 85 (new): The apparatus of claim 79 including at least four lamps associated with at least four reflectors.

Claim 86 (new): The apparatus of claim 79 wherein the plurality of lamps are positioned on opposing sides of the substrate.

Claim 87 (new): The apparatus of claim 86 wherein one opposing side of the substrate is supported by a susceptor and a portion of the plurality of lamps is positioned between the susceptor and a portion of the plurality of reflectors.

Claim 88 (new): The apparatus of claim 79 wherein the plurality of lamps are comprised by both outer and inner lamps.

Claim 89 (new): The apparatus of claim 79 wherein an entirety of the lamps reside below the reflectors.

Claim 90 (new): The apparatus of claim 89 wherein at least a portion of the reflectors are smooth and the smooth portion and the rough portion of the reflectors reside above the lamps.